



Data sheet Issue 11/22

DEX-1001

Solid Epoxy Resin

Product data

Decription

DEX-1001 is is a low molecular weight solid epoxy resin derived from a liquid epoxy resin and bisphenol a it can be hardening at room temperature or higher temperature

Packing

- 25KG/BAG

Technical Properties

Property	Unit	Value
Apperance		SOLID, NO MECHANICALI MPURITIES
Epoxy t equivalent weight	G/EQ	492 -530
Softening point	°C	64-76
Volatile	%	1 MAX

Applications

It can be hardening at room temperature or higher temperature, used for adhesion agent, anticorrosive coating, zinc dust ground coat, floor paint, decorated coating and varnish. It also can enhance the capability of alkyd-armine coating, to improve the levelling property of epoxy and polyester powder coating.

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